TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSII)

2SK3662

Switching Regulator, DC-DC Converter, Motor Drive Applications

• Low drain-source ON resistance: RDS (ON) = $9.4 \text{ m}\Omega$ (typ.)

• High forward transfer admittance: $|Y_{fs}| = 55 \text{ S (typ.)}$

• Low leakage current: $IDSS = 100 \mu A \text{ (max) (VDS} = 60 \text{ V)}$

• Enhancement-mode: $V_{th} = 1.3$ to 2.5 V ($V_{DS} = 10$ V, $I_{D} = 1$ mA)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	٧	
Drain current	DC (Note 1)	I _D	35	Α	
	Pulse (Note 1)	I _{DP}	105		
Drain power dissipation (Tc = 25°C)		P_{D}	35	W	
Single pulse avalanche energy (Note 2)		E _{AS}	204	mJ	
Avalanche current		I _{AR}	35	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	3.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 227 μH , I_{AR} = 35 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

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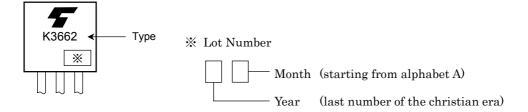
Electrical Characteristics (Ta = 25°C)

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	60	_	_	V
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	40	_	_	v
Gate threshold vo	oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	1.3	_	2.5	V
Drain-source ON resistance		_	V _{GS} = 4 V, ID = 18 A	_	12.5	19	- mΩ
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 18 A	_	9.4	12.5	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 18 A	28	55	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	5120	_	pF
Reverse transfer capacitance		C _{rss}		_	300	_	
Output capacitance		Coss		_	500	_	
Switching time	Rise time	t _r	10 V V _{GS} 0 V CC V _{DD} ≈ 30 V Duty ≤ 1%, t _w = 10 μs	_	6	_	- ns
	Turn-on time	t _{on}		_	19	_	
	Fall time	t _f		_	20	_	
	Turn-off time	t _{off}		_	115	_	
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≈ 48 V, V _{GS} = 10 V,	_	91	_	nC
Gate-source charge		Q _{gs}	$I_D = 35 \text{ A}$	_	70	_	
Gate-drain ("miller") charge		Q _{gd}			21	_	

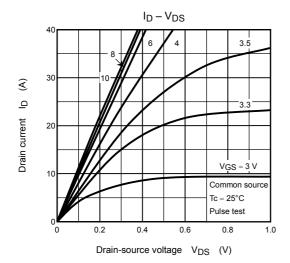
Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

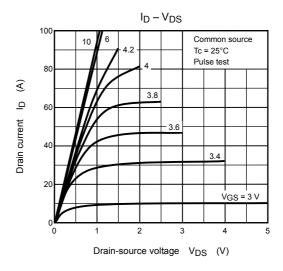
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	35	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	105	Α
Forward voltage (diode)	V _{DS2F}	I _{DR1} = 35 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	$I_{DR} = 35 \text{ A}, V_{GS} = 0 \text{ V},$		60	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 50 A/μs		58	_	nC

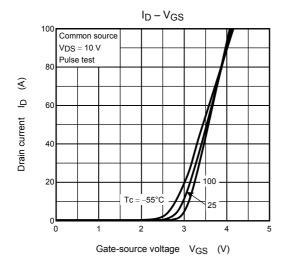
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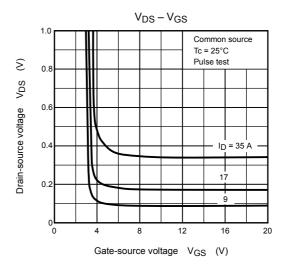


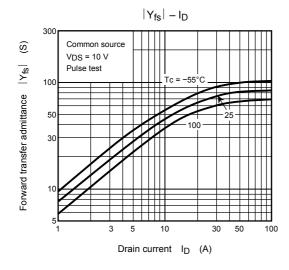
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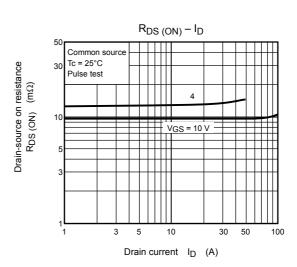




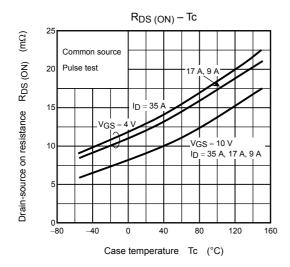


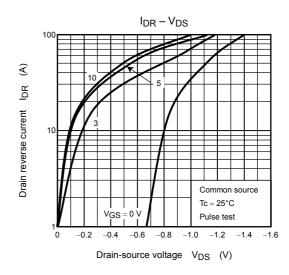


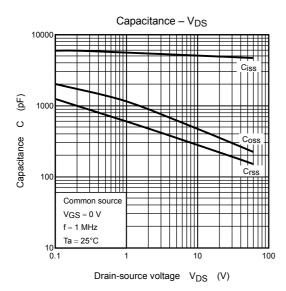


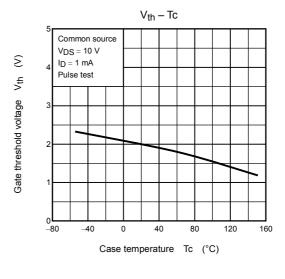


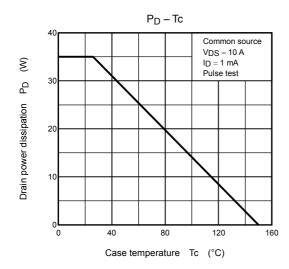
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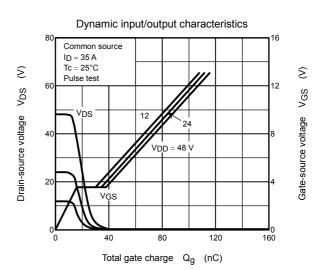


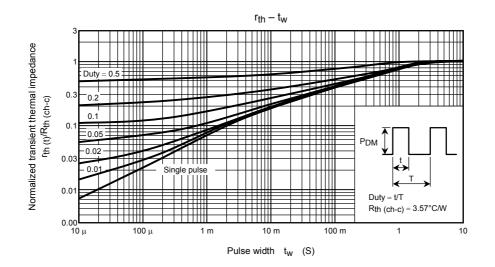


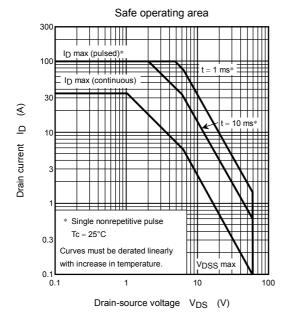


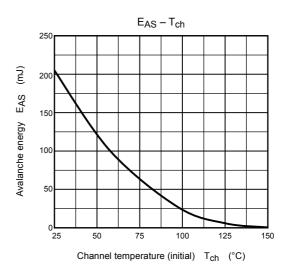


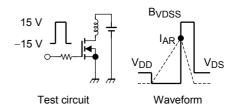












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 25~V,~L = 227~\mu H \end{aligned} \qquad \text{EAS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS} - V_{DD} \right)$$

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